

74ACT11646
OCTAL BUS TRANSCEIVER AND REGISTER
WITH 3-STATE OUTPUTS

SCAS061A – D2957, JULY 1987 – REVISED APRIL 1993

- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- **EPIC™** (Enhanced-Performance Implanted CMOS) 1- μ m Process
- 500-mA Typical Latch-Up Immunity at 125°C

description

These devices consist of bus transceiver circuits, 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. Data on the A or B bus will be clocked into the registers on the low-to-high transition of the appropriate clock pin (CAB or CBA). Figure 1 illustrates the four fundamental bus-management functions that can be performed with the octal bus transceivers and registers.

Enable (\bar{G}) and direction (DIR) pins are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either register or in both. The select controls (SAB and SBA) can multiplex stored and real-time (transparent mode) data. The circuitry used for select control will eliminate the typical decoding glitch which occurs in a multiplexer during the transition between stored and real-time data. The direction control determines which bus will receive data when enable \bar{G} is active (low). In the isolation mode (control \bar{G} high), A data may be stored in one register and/or B data may be stored in the other register.

When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The 74ACT11646 is characterized for operation from – 40°C to 85°C.

DW PACKAGE
(TOP VIEW)

\bar{G}	1	28	CAB
A1	2	27	SAB
A2	3	26	B1
A3	4	25	B2
A4	5	24	B3
GND	6	23	B4
GND	7	22	V _{CC}
GND	8	21	V _{CC}
GND	9	20	B5
A5	10	19	B6
A6	11	18	B7
A7	12	17	B8
A8	13	16	CBA
DIR	14	15	SBA

EPIC is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Copyright © 1993, Texas Instruments Incorporated

TEXAS
INSTRUMENTS

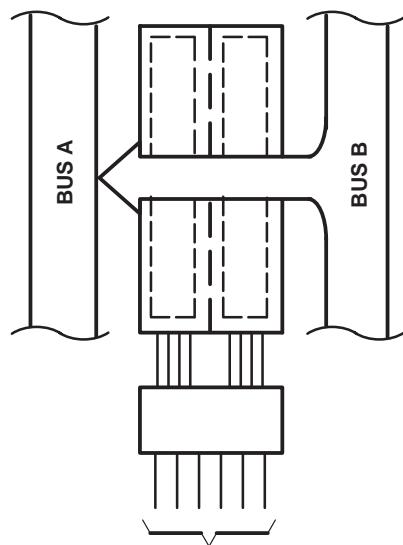
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

2-1

74ACT11646

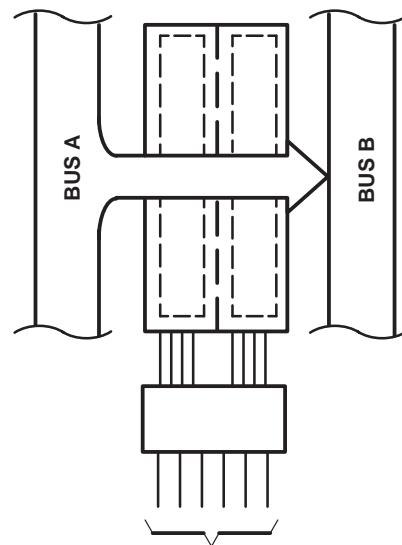
OCTAL BUS TRANSCEIVER AND REGISTER
WITH 3-STATE OUTPUTS

SCAS061A - D2957, JULY 1987 - REVISED APRIL 1993



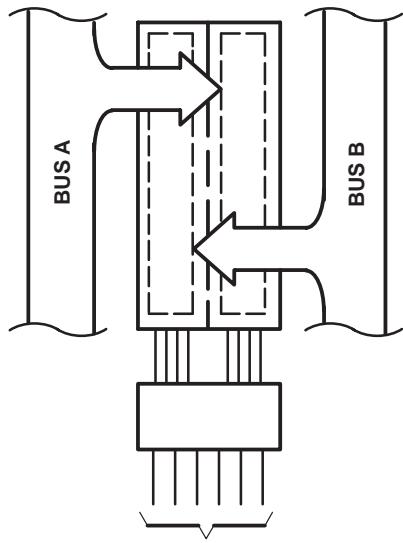
1	14	28	16	27	15
G	DIR	CAB	CBA	SAB	SBA
L	L	X	X	X	L

REAL-TIME TRANSFER BUS B TO BUS A



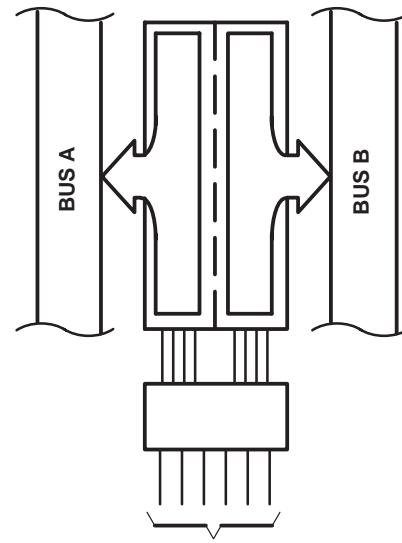
1	14	28	16	27	15
G	DIR	CAB	CBA	SAB	SBA
L	H	X	X	L	X

REAL-TIME TRANSFER BUS A TO BUS B



1	14	28	16	27	15
G	DIR	CAB	CBA	SAB	SBA
X	X	↑	X	X	X
X	X	X	↑	X	X

STORAGE FROM A, B, OR A AND B



1	14	28	16	27	15
G	DIR	CAB	CBA	SAB	SBA
L	L	X	H or L	X	H
L	H	H or L	X	H	X

TRANSFER STORED DATA TO A OR B

Figure 1. Bus-Management Functions

TEXAS
INSTRUMENTS

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

74ACT11646
OCTAL BUS TRANSCEIVER AND REGISTER
WITH 3-STATE OUTPUTS

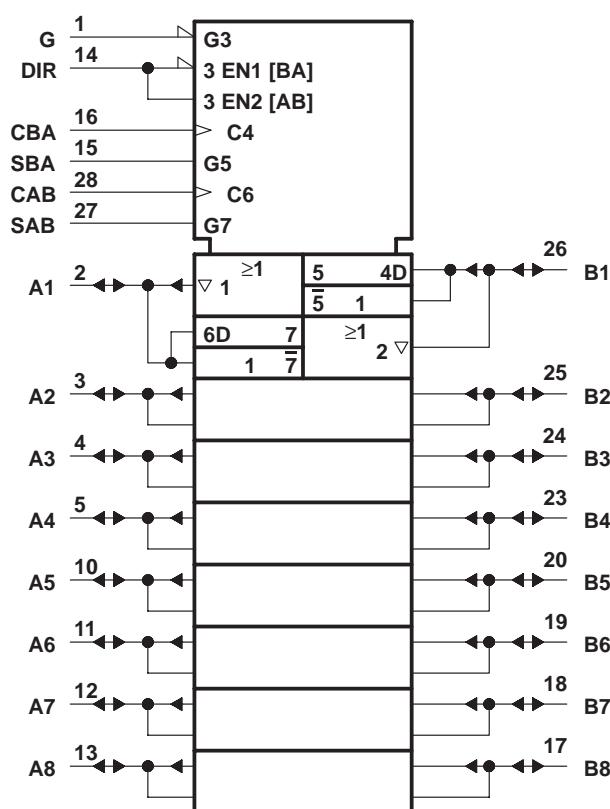
SCAS061A – D2957, JULY 1987 – REVISED APRIL 1993

FUNCTION TABLE

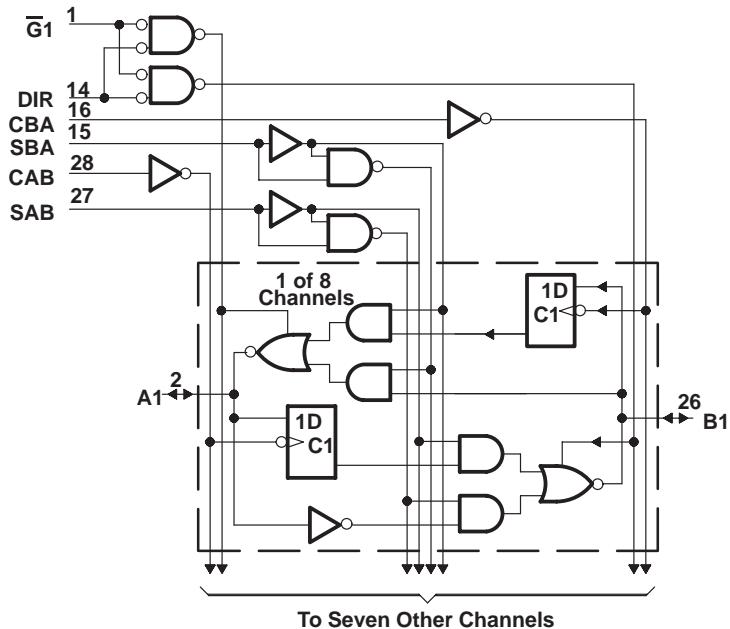
INPUTS						DATA I/O		OPERATION OR FUNCTION
\bar{G}	DIR	CAB	CBA	SAB	SBA	A1 THRU A8	B1 THRU B8	
X	X	\uparrow	X	X	X	Input	Unspecified†	Store A, B unspecified†
X	X	X	\uparrow	X	X	Unspecified†	Input	Store B, A unspecified†
H	X	\uparrow	\uparrow	X	X	Input	Input	Store A and B Data Isolation, hold storage
H	X	H or L	H or L	X	X	Output	Input	Real-Time B Data to A Bus Stored B Data to A Bus
L	L	X	X	X	L	Output	Output	Real-Time A Data to B Bus Stored A Data to B Bus
L	H	X	X	L	X	Input	Output	Real-Time A Data to B Bus Stored A Data to B Bus
L	H	H or L	X	H	X			

† The data output functions may be enabled or disabled by various signals at the \bar{G} and DIR inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low-to-high transition on the clock inputs.

logic symbol†



functional block diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984
and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to V_{CC} + 0.5 V
Output voltage range, V_O (see Note 1)	-0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 50 mA
Continuous current through V_{CC} or GND	± 200 mA
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

recommended operating conditions

		MIN	MAX	UNIT
V_{CC}	Supply voltage	4.5	5.5	V
V_{IH}	High-level input voltage	2		V
V_{IL}	Low-level input voltage		0.8	V
V_I	Input voltage	0	V_{CC}	V
V_O	Output voltage	0	V_{CC}	V
I_{OH}	High-level output current		-24	mA
I_{OL}	Low-level output current		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T_A	Operating free-air temperature	-40	85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	$T_A = 25^\circ C$			MIN	MAX	UNIT
			MIN	TYP	MAX			
V_{OH}	$I_{OH} = -50 \mu A$	4.5 V	4.4		4.4	V		
		5.5 V	5.4		5.4			
	$I_{OH} = -24 mA$	4.5 V	3.94		3.8			
		5.5 V	4.94		4.8			
	$I_{OH} = -75 mA^\ddagger$	5.5 V			3.85			
	$I_{OL} = 50 \mu A$	4.5 V		0.1	0.1		V	
V_{OL}		5.5 V		0.1	0.1			
$I_{OL} = 24 mA$	4.5 V		0.36	0.44				
	5.5 V		0.36	0.44				
$I_{OL} = 75 mA^\ddagger$	5.5 V			1.65				
I_{OZ}	A or B ports [§]	$V_O = V_{CC}$ or GND	5.5 V		± 0.5	± 5	μA	
I_I	\bar{G} or DIR	$V_I = V_{CC}$ or GND	5.5 V		± 0.1	± 1	μA	
I_{CC}		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		8	80	μA	
ΔI_{CC}^\dagger		One input at 3.4 V, Other inputs at GND or V_{CC}	5.5 V		0.9	1	mA	
C_i		$V_I = V_{CC}$ or GND	5 V		4.5		pF	
C_o		$V_O = V_{CC}$ or GND	5 V		12		pF	

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[§] For I/O ports, the parameter I_{OZ} includes the leakage current.

[¶] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC} .

74ACT11646
OCTAL BUS TRANSCEIVER AND REGISTER
WITH 3-STATE OUTPUTS

SCAS061A – D2957, JULY 1987 – REVISED APRIL 1993

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

		$T_A = 25^\circ C$		MIN	MAX	UNIT
		MIN	MAX			
f_{clock}	Clock frequency	0	105	0	105	MHz
t_w	Pulse duration, CAB or CBA high or low	4.8		4.8		ns
t_{su}	Setup time, A before CLK↑ or B before CBA↑	4.5		4.5		ns
t_h	Hold time, A after CAB↑ or B after CBA↑	2.5		2.5		ns

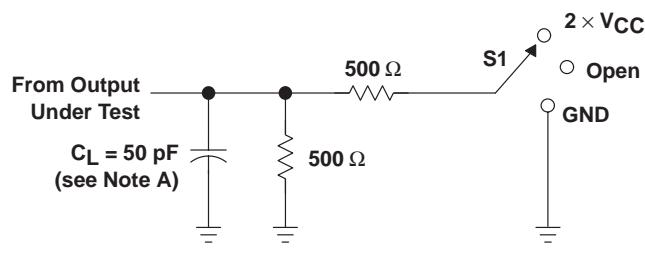
switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ C$			MIN	MAX	UNIT
			MIN	TYP	MAX			
f_{max}			105			105		MHz
t_{PLH}	A or B	B or A	1.5	7.3	10.1	1.5	11.5	ns
t_{PHL}			1.5	7.2	11	1.5	12	
t_{PZH}	\bar{G}	A or B	1.5	7.7	12.8	1.5	14.4	ns
t_{PZL}			1.5	9.2	13.8	1.5	15.3	
t_{PHZ}	\bar{G}	A or B	1.5	8.6	10.7	1.5	11.6	ns
t_{PLZ}			1.5	7.8	9.7	1.5	10.6	
t_{PLH}	CBA or CAB	A or B	1.5	8.8	11.9	1.5	13.5	ns
t_{PHL}			1.5	10	13.4	1.5	14.9	
t_{PZH}	DIR	A or B	1.5	10.2	13.7	1.5	15.3	ns
t_{PZL}			1.5	10.9	14.8	1.5	16.5	
t_{PHZ}	DIR	A or B	1.5	7.9	10.5	1.5	11.3	ns
t_{PLZ}			1.5	7.3	9.5	1.5	10.3	
t_{PLH}	SBA or SAB (A or B high)	A or B	1.5	6.7	10.3	1.5	11.5	ns
t_{PHL}			1.5	9.1	12.1	1.5	13.5	
t_{PLH}	SBA or SAB (A or B low)	A or B	1.5	8	10.9	1.5	12.4	ns
t_{PHL}			1.5	8.1	11.9	1.5	13.1	

operating characteristics, $V_{CC} = 5$ V, $T_A = 25^\circ C$

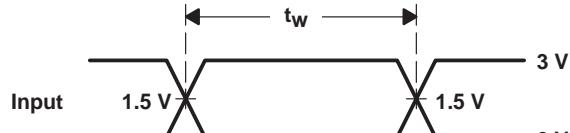
PARAMETER	TEST CONDITIONS		TYP	UNIT
	Outputs enabled	Outputs disabled		
C_{pd} Power dissipation capacitance per transceiver			63	
			14	pF

PARAMETER MEASUREMENT INFORMATION

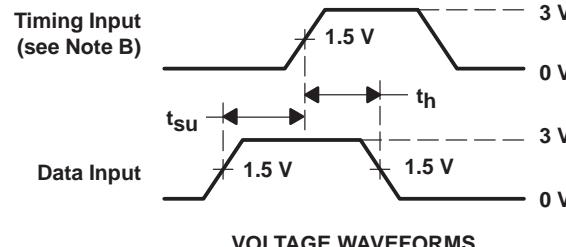


TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND

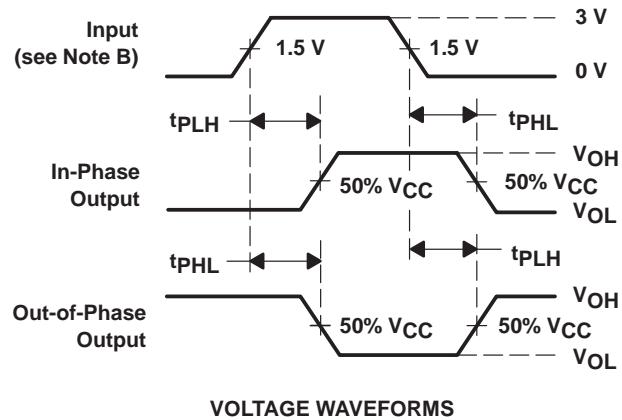
LOAD CIRCUIT



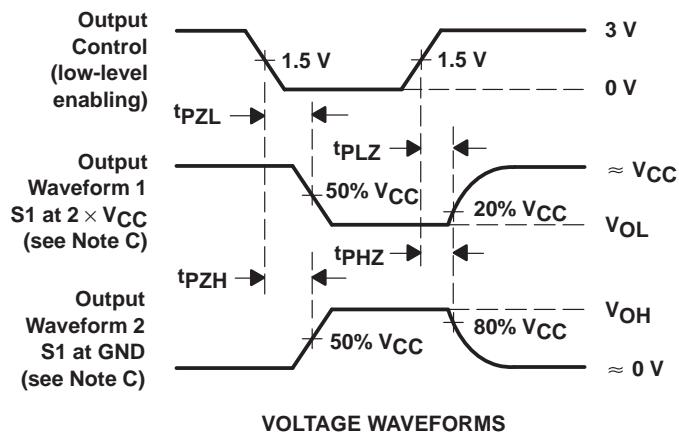
VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS

NOTES: A. C_L includes probe and jig capacitance.

B. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.

C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

D. The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated